CND0214A

Infrared Optocal Module (IrDA)

Infrared data link for cellular phones, peripheral devices

■ Features

- Compliant with IrDA Ver.1.2
- Corresponding low I/O (interface) voltage: 1.5 V
- Corresponding reflow solder (260°C)
- Ultra-small top view package (2.0 mm \times 8.2 mm \times 1.7 mm)

■ Type

• GaAlAs LED + IC + PIN Photodiode

■ Absolute Maximum Ratings $T_a = 25$ °C±3°C

Parameter	Symbol	Rating	Unit
Operating supply voltage	V_{CC}	-0.5 to $+3.8$	V
Output voltage	Vo	-0.5 to $+3.8$	V
Input voltage	V _I	-0.5 to $+3.8$	V
Shutdown input voltage	V_{SD}	-0.5 to $+3.8$	V
LED operating supply voltage	V_{LEDA}	-0.5 to $+7.0$	V
Pulse forward current *	I _{FP}	200	mA
Low level output current	I_{OL}	10	mA
Operating ambient temperature	T _{opr}	-20 to +70	°C
Storage temperature	T _{stg}	-30 to +85	°C

Note) *: $tw \le 90 \mu s$, $Duty \le 20 \%$

■ Operation Condition

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating supply voltage	V_{CC}	de sillo illo	2.4	2.8	3.3	V
LED operating supply voltage	V_{LEDA}		2.7		4.5	V
Input / output supply voltage	V_{IO}		1.5	1.8	V _{CC}	V

■ Electrical-Optical Characteristics $V_{CC} = V_{IO} = 2.8 \text{ V}, T_a = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
High level supply current *1	I_{CCH}	$V_{LEDA} = 3.6 \text{ V}, V_{I} = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$		90	120	μΑ
Shut down supply current *1	I _{CCSD}	$V_{I} = 0.5 \text{ V},$ $V_{IO} \ge V_{SD} \ge V_{IO} - 0.3 \text{ (SD = High)}$		10	200	nA
Maximum reception distance *5	L _{max}	V_{LEDA} = 2.7 V to 4.5 V, $V_{SD} \le 0.5$ V, External components	23			cm
Data Rates	_		9.6		115.2	kbps
SD high level input voltage	V _{IHSD}		V _{IO} - 0.5		V _{IO}	V
SD low level input voltage	$V_{\rm ILSD}$		0		0.5	V

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■ Electrical-Optical Characteristics (Continued) $V_{CC} = V_{IO} = 2.8 \text{ V}, T_a = 25^{\circ}\text{C} \pm 3^{\circ}\text{C}$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Transmitter							
Peak emission wavelength		$\lambda_{ m P}$	$I_{FP} = 60 \text{ mA}, \text{ Duty } 3/16$	850	870	900	nm
Pulse forward current *1		I_{FP}	$V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V}$	40	60	90	mA
Center radiant intensity *1,2	$\theta_T = 0$	I _e	$V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V}$	12	18		mW/sr
Center radiant intensity	$\theta_{\rm T} = \pm 15$	I _{e15}	$V_{LEDA} = 3.2 \text{ V}, V_{SD} \le 0.5 \text{ V}$	7	12		mW/sr
High level input voltage *1		V_{IH}	$V_{CC} = 2.4 \text{ V to } 3.3 \text{ V}, V_{SD} \le 0.5 \text{ V}$	$V_{IO} - 0.5$		V _{IO}	V
Low level input voltage *1		V_{IL}	$V_{CC} = 2.4 \text{ V to } 3.3 \text{ V}, V_{SD} \le 0.5 \text{ V}$	0		0.5	V
TX half-angle		θ_{T}		±15			0
LED optical pulse width		T_{WT}	TXD Pulse = 1.6 μs	1.41	1.6	2.2	μs
Rise time *1,3		t _r	$t_{\rm w} = 1.6 \ \mu \text{s}, R_{\rm L} = 50 \ \Omega$			0.2	μs
Fall time *1, 3		t_{f}	$t_{\rm w} = 1.6 \ \mu \rm s, \ R_{\rm L} = 50 \ \Omega$			0.2	μs
TX wake up time *8		t _{Twu}			0.3	1	μs
Receiver				N			
Minimum input irradiance		E _{I min}	$V_{SD} \le 0.5 \text{ V}$	like,		5	μW/cm ²
High level output voltage *6		V _{OH}	Non signal condition $I_{OH} = -200 \; \mu\text{A}, V_{SD} \leq 0.5 \; V$	V _{IO} -0.3		V _{IO}	V
Low level output voltage *7		V _{OL}	$I_{OL} = 500 \mu\text{A}, V_{SD} \le 0.5 \text{V}$	0		0.5	V
RX half angle		θ_{R}	100	±15			0
RXD output pulse width		T_{WR}	$C_L = 15 \text{ pF}, 9.6 \text{ kbps to } 115.2 \text{ kbps}$	1.0	2.3	4.2	μs
RX wake up time *9		t_{Rwu}	$E_I = 8.1 \mu\text{W/cm}^2$	6	200	400	μs
Receiver latency time		$t_{\rm L}$	$E_I = 8.1 \mu\text{W/cm}^2$	80	100	200	μs
Rise time *4		t _r	$C_L = 10 \text{ pF}$	0,	50	200	ns
Fall time *4		t_{f}	$C_L = 10 \text{ pF}$	6 96	50	200	ns

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*2:

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*4:

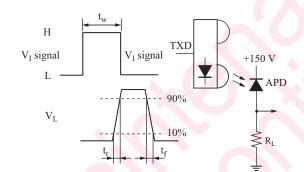
■ Electrical-Optical Characteristics (Continued)

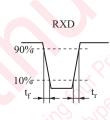
Note) Measuring circuit

*1: $\begin{array}{c|c} & & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\ &$

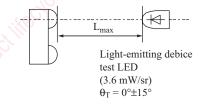
Hθ_T -θ_T Side View

*3:

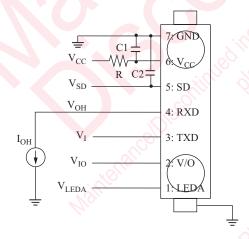


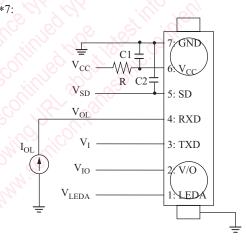


*9:

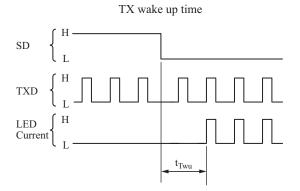


*6:





*8:



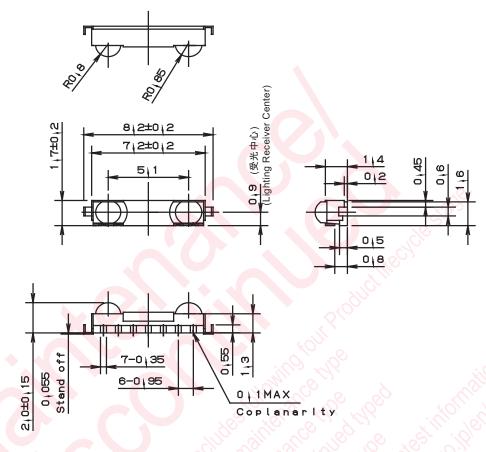
RX wake up time SD $\left\{ \begin{array}{c} H \\ L \end{array} \right.$ Signal $\left\{ \begin{array}{c} H \\ L \end{array} \right.$ RXD $\left\{ \begin{array}{c} H \\ L \end{array} \right.$

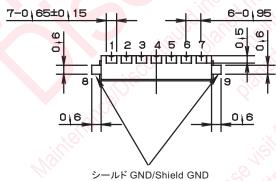
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■ Package (Unit: mm)

KMTLTM7K0001





• Pin name

1. LEDA

6. V_{CC}

 $2. V_{IO}$

7. GND

3. TXD

8. Shield GND

4. RXD

9. Shield GND

5. SD

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